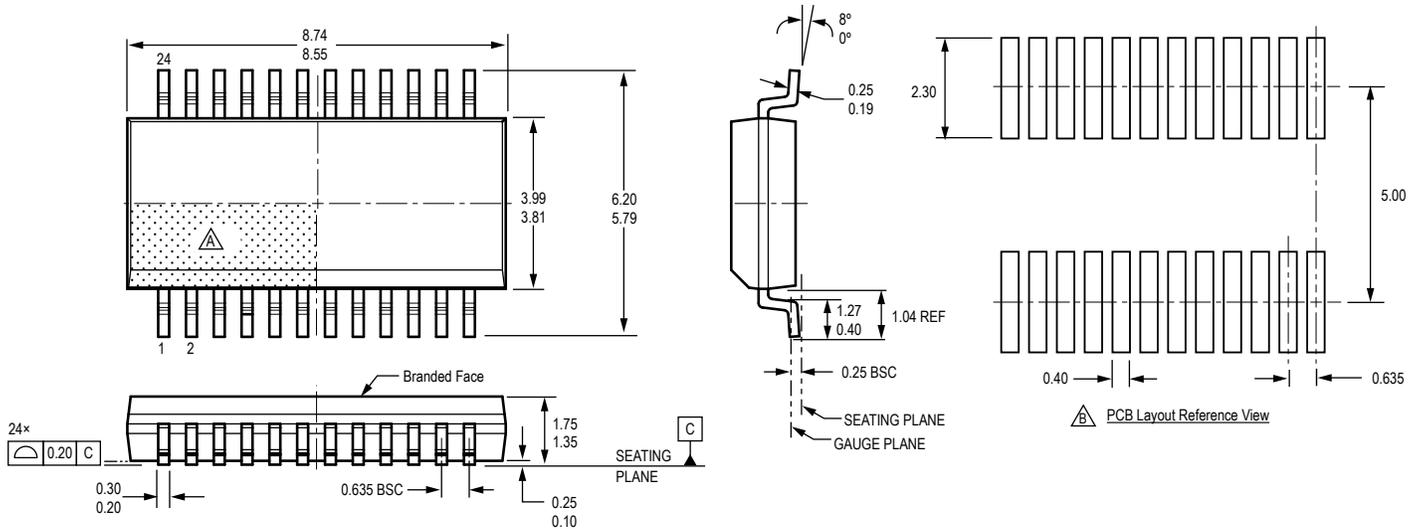
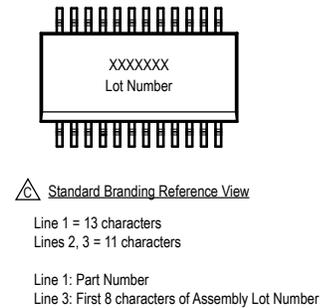
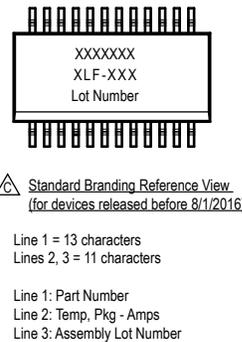


### For Reference Only – Not for Tooling Use

(Reference Allegro DWG-0000387, Rev. 2 and JEDEC MO-137 AE)  
 Dimensions in millimeters  
 Dimensions exclusive of mold flash, gate burrs, and dambar protrusions  
 Exact case and lead configuration at supplier discretion within limits shown



- ⚠ Terminal #1 mark area
- ⚠ Reference pad layout (reference IPC7351 SOP63P600X175-24M)  
All pads a minimum of 0.20 mm from all adjacent pads; adjust as necessary to meet application process requirements and PCB layout tolerances
- ⚠ Branding scale and appearance at supplier discretion



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